

2A, 20V - 150V Schottky Barrier Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for over-voltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- Low voltage, high freq. inverter
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.093g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	2	A
V_{RRM}	20 - 150	V
I_{FSM}	50	A
$T_{J\ MAX}$	125, 150	°C
Package	DO-214AA (SMB)	
Configuration	Single die	



DO-214AA (SMB)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)										
PARAMETER	SYMBOL	SS	SS	SS	SS	SS	SS	SS	SS	UNIT
		22H	23H	24H	25H	26H	29H	210H	215H	
Marking code on the device		SS 22	SS 23	SS 24	SS 25	SS 26	SS 29	SS 210	SS 215	
Repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	90	100	150	V
Reverse voltage, total rms value	$V_{R(RMS)}$	14	21	28	35	42	63	70	105	V
Forward current	I_F	2								A
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	50								A
Critical rate of rise of off-state voltage	dV/dt	10,000								V/ μs
Junction temperature	T_J	- 55 to +125				- 55 to +150				°C
Storage temperature	T_{STG}	- 55 to +150								°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	24	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	70	°C/W

ELECTRICAL SPECIFICATIONS (TA = 25°C unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT				
Forward voltage ⁽¹⁾	SS22H SS23H SS24H	$I_F = 2A, T_J = 25^\circ C$	V_F	-	0.50	V			
	SS25H SS26H			-	0.70	V			
	SS29H SS210H			-	0.85	V			
	SS215H			-	0.95	V			
	Forward voltage ⁽¹⁾			SS22H SS23H SS24H	$I_F = 2A, T_J = 100^\circ C$	V_F	-	0.40	V
				SS25H SS26H			-	0.65	V
SS29H SS210H		-	0.70	V					
SS215H		-	0.80	V					
Reverse current @ rated $V_R^{(2)}$		SS22H SS23H SS24H	$T_J = 25^\circ C$	I_R			-	400	μA
		SS25H SS26H					-	100	μA
	SS29H SS210H SS215H	-			100	μA			
	Reverse current @ rated $V_R^{(2)}$	SS22H SS23H SS24H			$T_J = 100^\circ C$	I_R	-	10	mA
		SS25H SS26H					-	5	mA
		SS29H SS210H SS215H					-	-	mA

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Reverse current @ rated $V_R^{(2)}$	SS22H	$T_J = 125^\circ\text{C}$	I_R	-	-	mA
	SS23H					
	SS24H					
	SS25H			-	-	mA
	SS26H					
	SS29H					
SS210H	5	mA				
SS215H						

Notes:

1. Pulse test with $PW = 0.3\text{ms}$
2. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
SS2xH	DO-214AA (SMB)	3,000 / Tape & Reel

Notes:

1. "x" defines voltage from 20V(SS22H) to 150V(SS215H)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

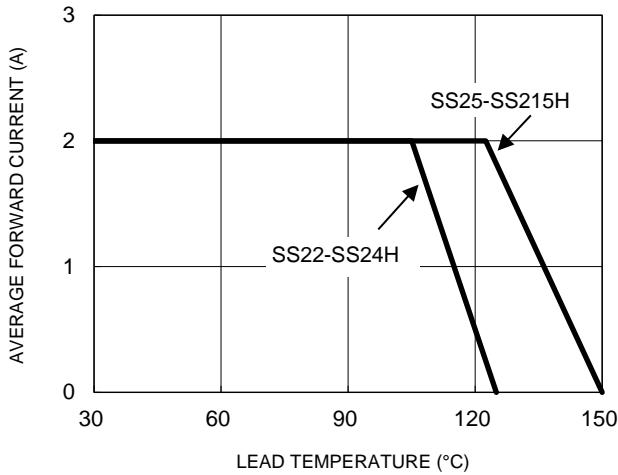


Fig.2 Typical Junction Capacitance

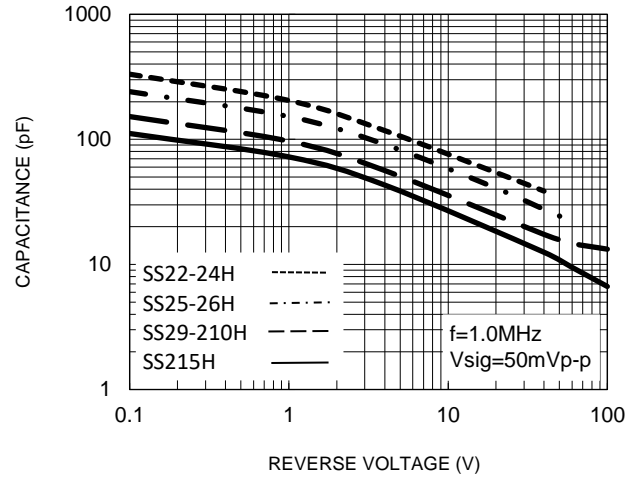


Fig.3 Typical Reverse Characteristics

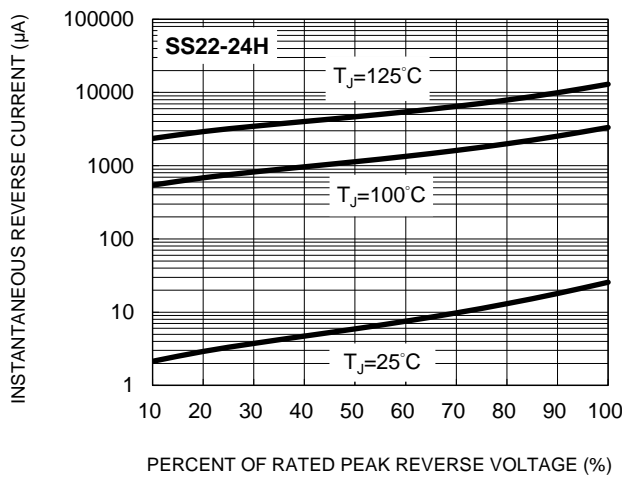


Fig.4 Typical Forward Characteristics

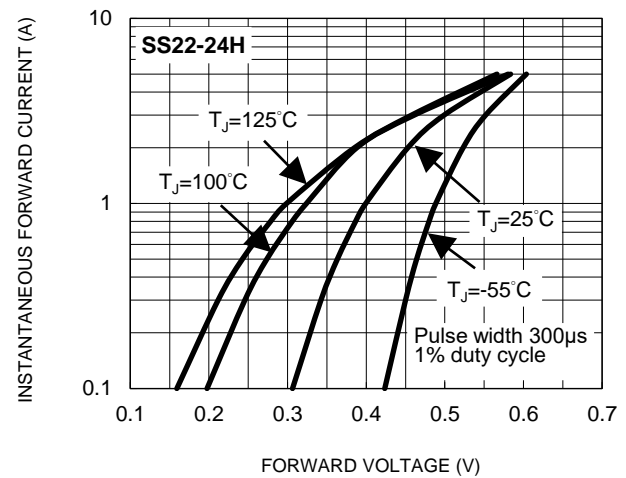


Fig.5 Typical Reverse Characteristics

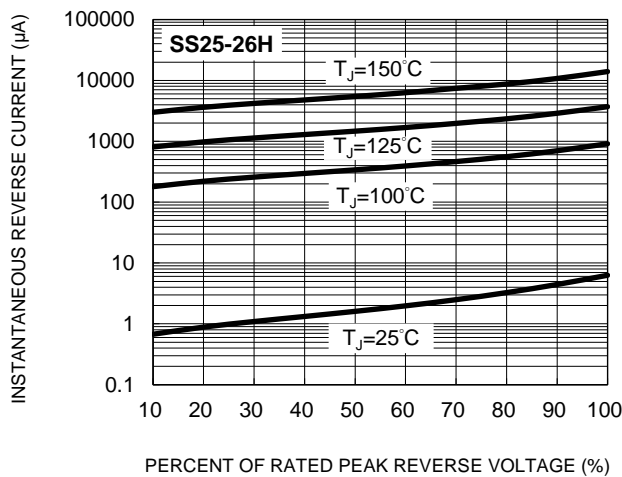
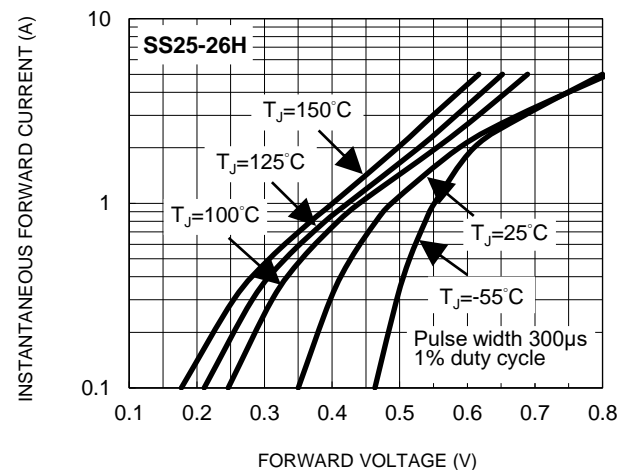


Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.7 Typical Reverse Characteristics

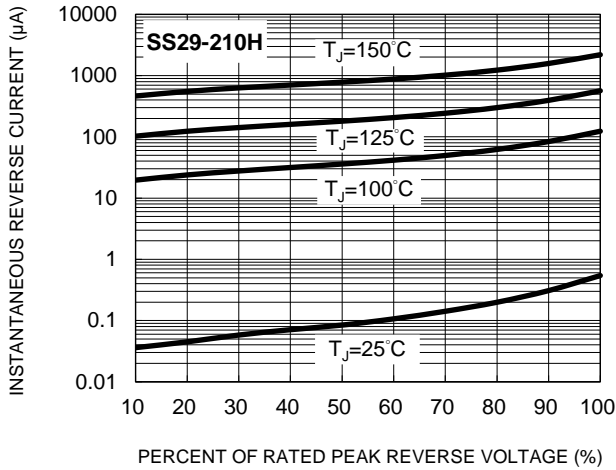


Fig.8 Typical Forward Characteristics

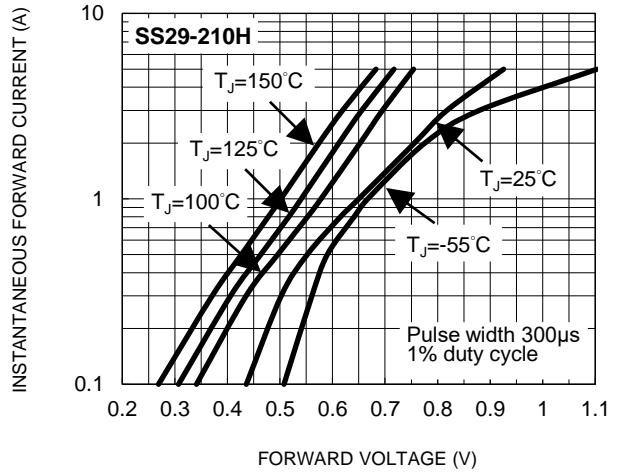


Fig.9 Typical Reverse Characteristics

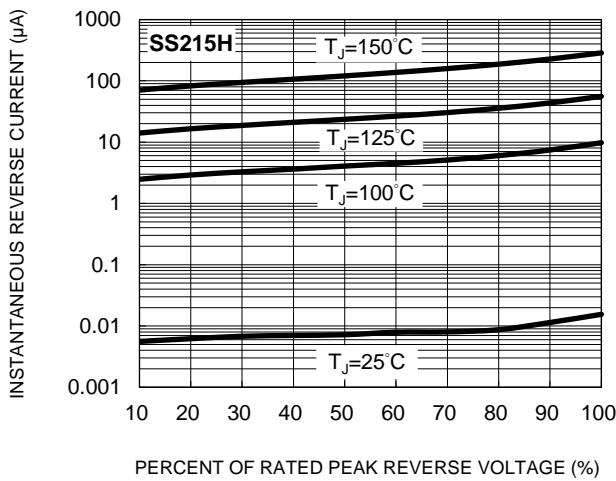


Fig.10 Typical Forward Characteristics

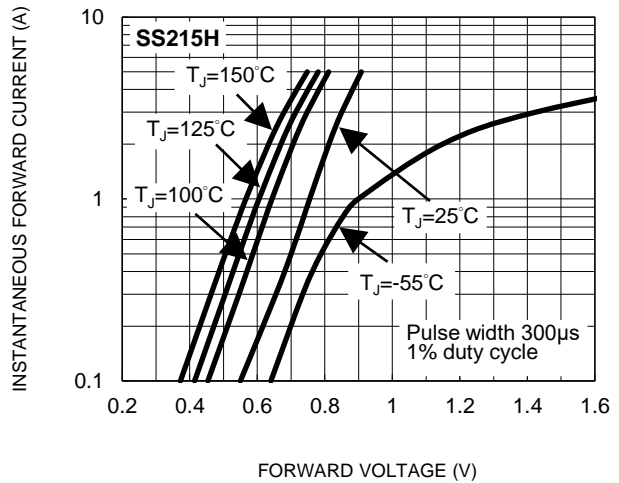
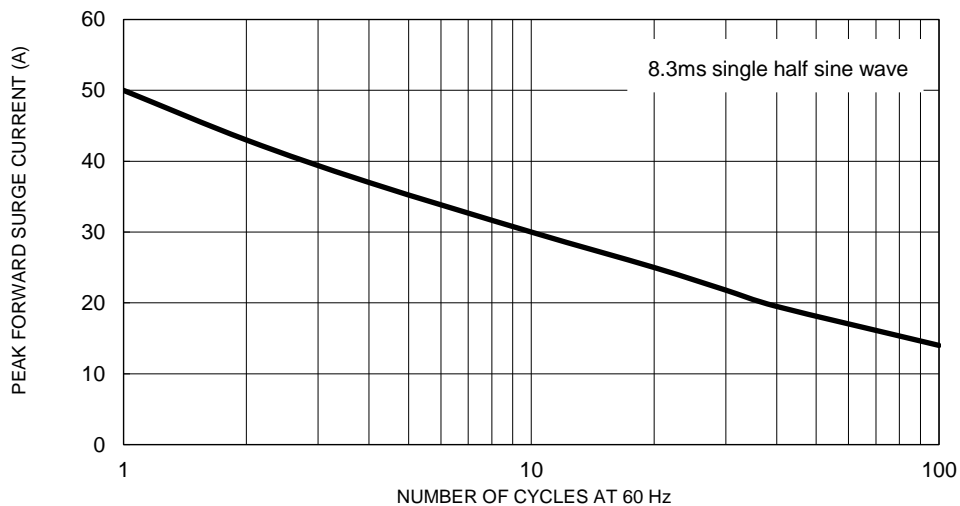
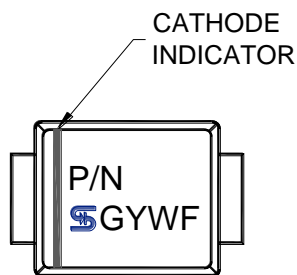
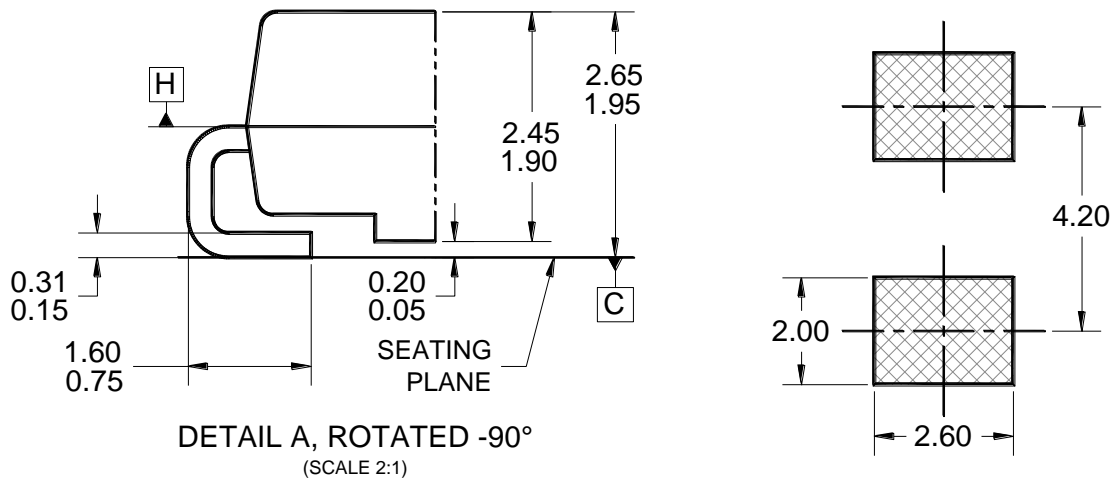
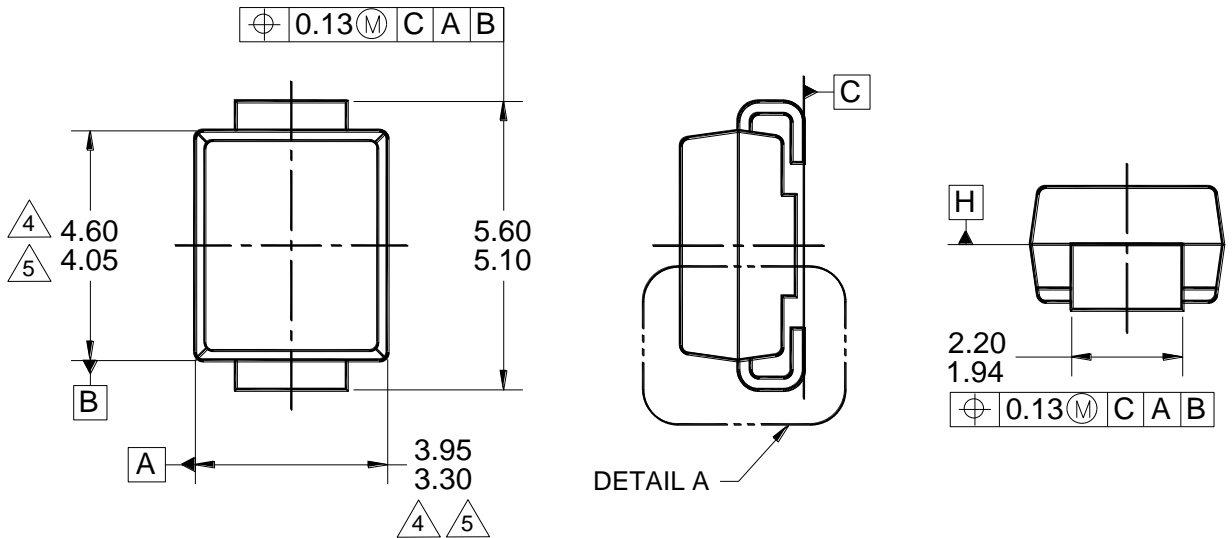


Fig.11 Maximum Non-Repetitive Forward Surge Current



PACKAGE OUTLINE DIMENSIONS

DO-214AA (SMB)



MARKING DIAGRAM

P/N = MARKING CODE
G = GREEN COMPOUND
YW = DATE CODE
F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AA, ISSUE D.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
6. DWG NO. REF: HQ2SD07-DO214SMB-035 REV A.

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.